SiHG47N65E



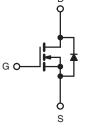


E Series Power MOSFET

PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	700			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.072			
Q _g max. (nC)	273			
Q _{gs} (nC)	46			
Q _{gd} (nC)	79			
Configuration	Single			

TO-247AC





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG47N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	650	v
Gate-Source Voltage			V _{GS}	± 30	
Continuous Drain Current (T _{.I} = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	1	47	
Continuous Drain Current (1j = 150°C)	V _{GS} at 10 V	T _C = 100 °C	I _D	30	А
Pulsed Drain Current ^a			I _{DM}	139	
Linear Derating Factor				3.3	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	1410	mJ
Maximum Power Dissipation			PD	417	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$			al) / / alt	37)//
Reverse Diode dV/dt ^d			dV/dt	9	V/ns
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 10 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

S15-0291-Rev. D, 23-Feb-15

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RoHS COMPLIANT HALOGEN FREE



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	- 40 - 0.3				-		
Maximum Junction-to-Case (Drain)	R _{thJC}					°C/W		
	' 'thJC			0.0				
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 2	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.70	-	V/°(
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
			V _{GS} = ± 20	V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30	V	-	-	± 1	μA
Zara Cata Valtaga Dusia Comunit		V _{DS} =	= 650 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}			/, T _J = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 24 A		-	0.060	0.072	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 24 A		-	16.7	-	S	
Dynamic	•	•			•	•	•	
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	5682	-	pF	
Output Capacitance	C _{oss}			-	251	-		
Reverse Transfer Capacitance	C _{rss}			-	1	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}			-	192	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	- V _{DS} = 0 V	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	665	-	1
Total Gate Charge	Qq				-	182	273	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 24	A, V _{DS} = 520 V	-	46	-	
Gate-Drain Charge	Q _{gd}				-	79	-	
Turn-On Delay Time	t _{d(on)}				-	47	94	
Rise Time	t _r	Vnn	= 520 V, I _D	= 6 A,	-	87	131	1
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	= 10 V, R _g =	= 9.1 Ώ	-	156	234	ns
Fall Time	t _f			-	103	206	1	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.64	-	Ω	
Drain-Source Body Diode Characterist	. ž							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	47	_	
Pulsed Diode Forward Current	I _{SM}	Ũ	integral reverse p - n junction diode		-	-	139	A
Diode Forward Voltage	V _{SD}	T _{.1} = 25 °C	C, I _S = 24 A	, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	<u> </u>			-	753	1506	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	5 °C, I _F = Is	s = 24 A,	-	14	28	μΟ
Reverse Recovery Current	I _{RRM}	dl/dt =	100 A/µs, V	v _R = 25 V	_	28		A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPCIAL CHARACTERISTICS (25 °C, unless otherwise noted)

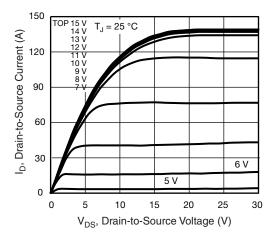


Fig. 1 - Typical Output Characteristics

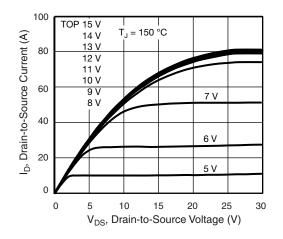


Fig. 2 - Typical Output Characteristics

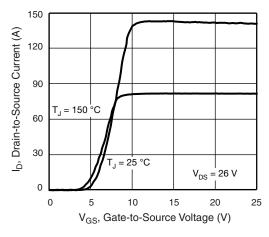


Fig. 3 - Typical Transfer Characteristics

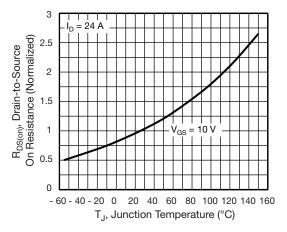


Fig. 4 - Normalized On-Resistance vs. Temperature

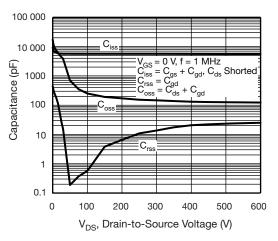


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

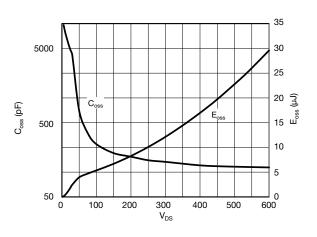


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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SiHG47N65E

Vishay Siliconix

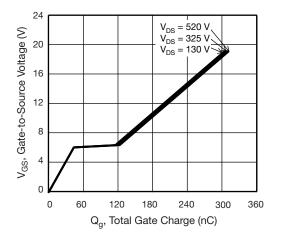


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

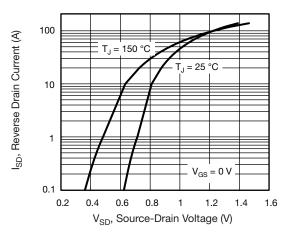


Fig. 8 - Typical Source-Drain Diode Forward Voltage

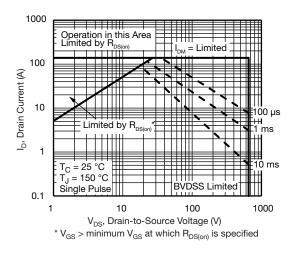


Fig. 9 - Maximum Safe Operating Area

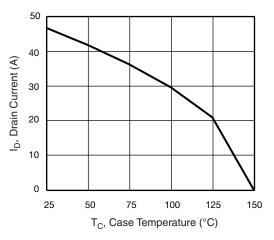


Fig. 10 - Maximum Drain Current vs. Case Temperature

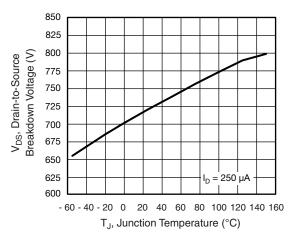
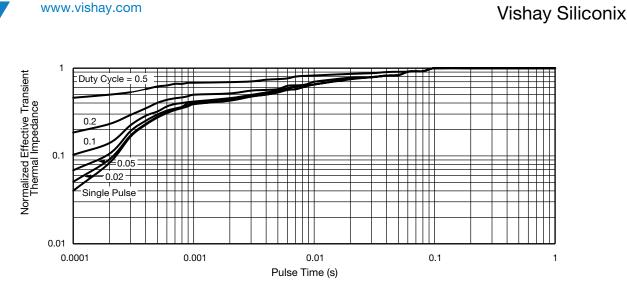


Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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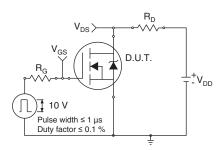


Fig. 13 - Switching Time Test Circuit

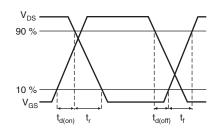


Fig. 14 - Switching Time Waveforms

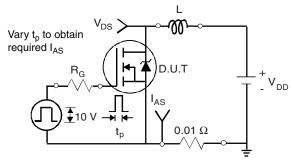


Fig. 15 - Unclamped Inductive Test Circuit

V_{DS} V_{DD} V_{DS} I_{AS}

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Fig. 16 - Unclamped Inductive Waveforms

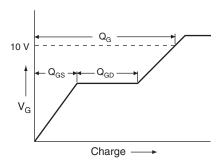


Fig. 17 - Basic Gate Charge Waveform

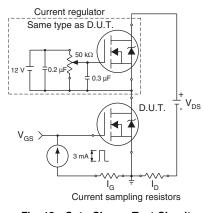
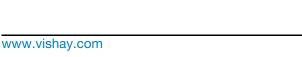


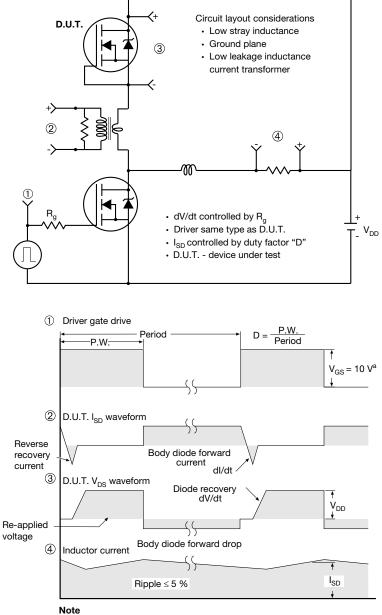
Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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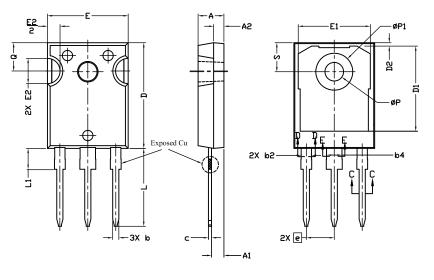
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TO-247AC (High Voltage)

VERSION 1: FACILITY CODE = 9





Section C--C, D--D, E--E

	MILLIN		
DIM.	MIN.	MAX.	NOTES
А	4.83	5.21	
A1	2.29	2.55	
A2	1.50	2.49	
b	1.12	1.33	
b1	1.12	1.28	
b2	1.91	2.39	6
b3	1.91	2.34	
b4	2.87	3.22	6, 8
b5	2.87	3.18	
С	0.55	0.69	6
c1	0.55	0.65	
D	20.40	20.70	4

	MILLIN		
DIM.	MIN.	MAX.	NOTES
D1	16.25	16.85	5
D2	0.56	0.76	
E	15.50	15.87	4
E1	13.46	14.16	5
E2	4.52	5.49	3
е	5.44	BSC	
L	14.90	15.40	
L1	3.96	4.16	6
ØР	3.56	3.65	7
Ø P1	7.19 ref.		
Q	5.31	5.69	
S	5.54	5.74	

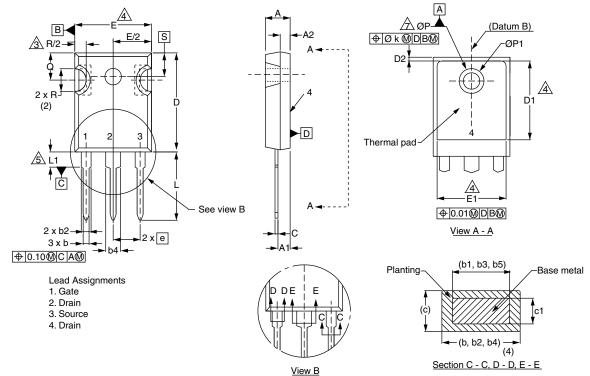
Notes

- ⁽¹⁾ Package reference: JEDEC[®] TO247, variation AC
- (2) All dimensions are in mm
- ⁽³⁾ Slot required, notch may be rounded
- (4) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁵⁾ Thermal pad contour optional with dimensions D1 and E1
- (6) Lead finish uncontrolled in L1
- (7) Ø P to have a maximum draft angle of 1.5° to the top of the part with a maximum hole diameter of 3.91 mm
- (8) Dimension b2 and b4 does not include dambar protrusion. Allowable dambar protrusion shall be 0.1 mm total in excess of b2 and b4 dimension at maximum material condition

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VERSION 2: FACILITY CODE = Y



MILLIM	MILLIMETERS			MILLIMETERS			
DIM.	MIN.	MAX.	NOTES	DIM.	MIN.	MAX.	NOTE
А	4.58	5.31		D2	0.51	1.30	
A1	2.21	2.59		E	15.29	15.87	
A2	1.17	2.49		E1	13.72	-	
b	0.99	1.40		е	5.46	BSC	
b1	0.99	1.35		Øk	0.	254	
b2	1.53	2.39		L	14.20	16.25	
b3	1.65	2.37		L1	3.71	4.29	
b4	2.42	3.43		ØP	3.51	3.66	
b5	2.59	3.38		Ø P1	-	7.39	
С	0.38	0.86		Q	5.31	5.69	
c1	0.38	0.76		R	4.52	5.49	
D	19.71	20.82		S	5.51	BSC	
D1	13.08	-					

Notes

- ⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- ⁽⁴⁾ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- ⁽⁷⁾ Outline conforms to JEDEC outline TO-247 with exception of dimension c

Revision: 08-Jan-2020



Vishay

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